TE Internal #: 2174988-2

TE Internal Description: SOCKET ASSY LGA2011-1 0.76um Au

LGA 2011 Sockets

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Connectors > Socket Connectors > IC Sockets > LGA Sockets > LGA 2011 Sockets











IC Socket Type: LGA 2011

Number of Positions: 2011

Contact Mating Area Plating Material Thickness: [30 µin]

Centerline (Pitch): 1.02 mm [ .04 in ]

Termination Method to PCB: Surface Mount - Solder Ball

All LGA 2011 Sockets (0)

### **Features**

# **Industry Standards**

| UL Flammability Rating | UL 94V-0 |
|------------------------|----------|
|------------------------|----------|

# **Body Features**

| Frame Style | Square |  |
|-------------|--------|--|
| ,           |        |  |

# **Packaging Features**

| Tray Color       | Blue |
|------------------|------|
| Packaging Method | Tray |

# Operation/Application

| Circuit Application | Signal  |  |
|---------------------|---------|--|
| Siredit Application | 3191141 |  |

# **Product Type Features**

| Connector & Contact Terminates To | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Connector System                  | Board-to-Board        |

# **Housing Features**

| Housing Color | Black |
|---------------|-------|
|---------------|-------|



| Housing Material                     | High Temperature Thermoplastic    |
|--------------------------------------|-----------------------------------|
| Centerline (Pitch)                   | 1.02 mm[.04 in]                   |
| Contact Features                     |                                   |
| Contact Mating Area Plating Material | Gold                              |
| Contact Base Material                | Copper Alloy                      |
| IC Socket Type                       | LGA 2011                          |
|                                      | 30 μin                            |
| Contact Current Rating (Max)         | .5 A                              |
| Configuration Features               |                                   |
| Number of Positions                  | 2011                              |
| Grid Spacing                         | 1.016 x .8814 mm[.040 x .0347 in] |
| Termination Features                 |                                   |
| Termination Method to PCB            | Surface Mount - Solder Ball       |
| Mechanical Attachment                |                                   |
| Connector Mounting Type              | Board Mount                       |

**Product Compliance** 

EU ELV Compliance

EU RoHS Compliance

Other

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC |
| Halogen Content                               | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free                                       |
| Solder Process Capability                     | Reflow solder capable to 260°C  |
| Product Compliance Disclaimer                 |   |

Compliant

Compliant



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Customers Also Bought





















#### **Documents**

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2174988-2\_D.2d\_dxf.zip

English

**Customer View Model** 



ENG\_CVM\_CVM\_2174988-2\_D.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2174988-2\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Product Specification** 

English